

Ultra Small Low Profile 0603 Balun 50Ω to 100Ω Balanced

Description

The BD3150L50100AHF is an ultra-small low profile balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering the MMDS and the low end of the UWB frequency ranges. The BD3150L50100AHF is ideal for high volume manufacturing and is higher performance than traditional ceramic baluns. The BD3150L50100AHF has an unbalanced port impedance of 50Ω and a 100Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD3150L50100AHF is available on tape and reel for pick and place high volume manufacturing.

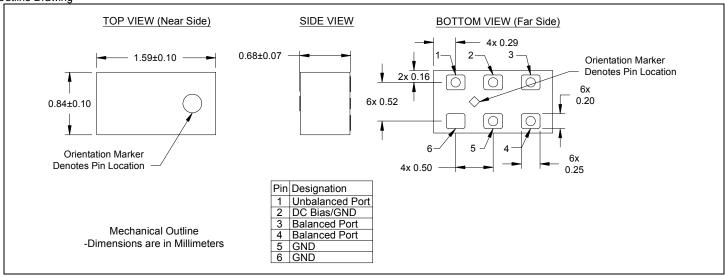
Detailed Electrical Specifications: Specifications subject to change without notice.

Features:

- 3100 5000 MHz
- 0.7mm Height Profile
- 50 Ohm to 2 x 50 Ohm
- UWB & MMDS
- Low Insertion Loss
- Input to Output DC Isolation
- Surface Mountable
- Tape & Reel
- Non-conductive Surface
- RoHS Compliant
- Halogen Free

	ROOM (25°C)			
Parameter	Min.	Тур.	Max	Unit
Frequency	3100		5000	MHz
Unbalanced Port Impedance		50		Ω
Balanced Port Impedance		100	_	Ω
Return Loss	9.5	12		dB
Insertion Loss*		8.0	1.1	dB
Amplitude Balance		0.5	0.9	dB
Phase Balance		4.0	9.0	Degrees
0.455		28		
CMRR	_		_	dB
Power Handling			2	Watts
Operating Temperature	-55		+85	°C

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C) Outline Drawing

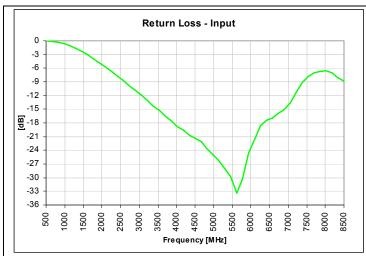


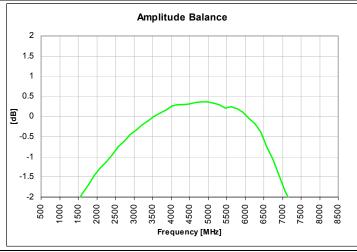
Typical Broadband Performance: 500 MHz. to 8500 MHz.

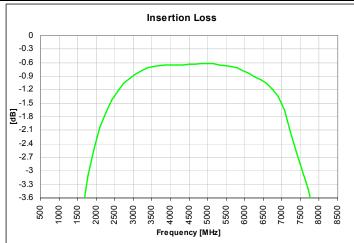


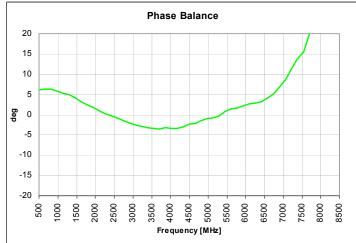
Visit us at www.anaren.com

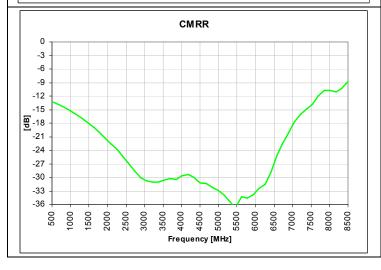












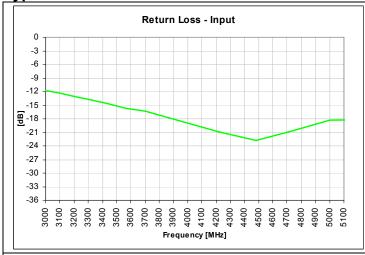
Visit us at www.anaren.com

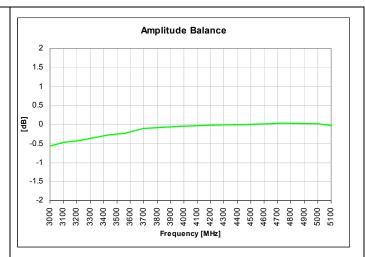


ModelBD3150L50100AHF

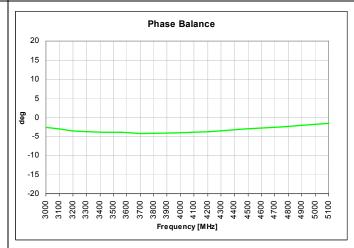
Rev A

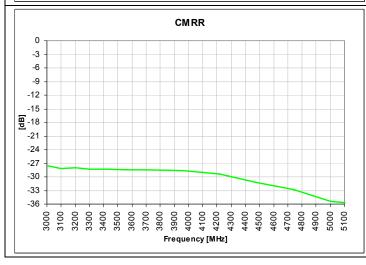
Typical Performance: 3000 MHz. to 5100 MHz.













Visit us at www.anaren.com



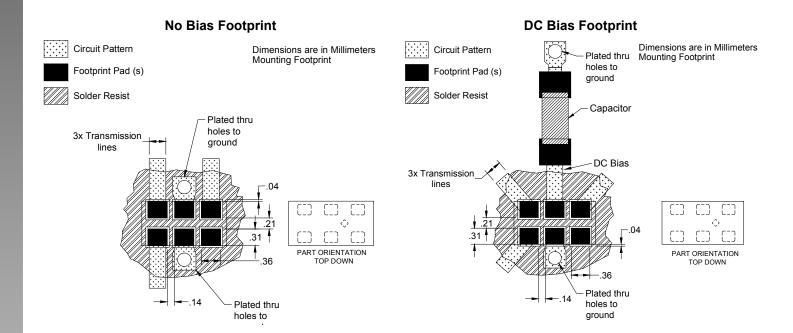


Mounting Configuration:

In order for Xinger surface mount components to work optimally, the proper impedance transmission lines must be used to connect to the RF ports. If this condition is not satisfied, insertion loss, Isolation and VSWR may not meet published specifications.

All of the Xinger components are constructed from organic PTFE based composites which possess excellent electrical and mechanical stability. Xinger components are compliant to a variety of ROHS and Green standards and ready for Pb-free soldering processes. Pads are Gold plated with a Nickel barrier.

An example of the PCB footprint used in the testing of these parts is shown below. An example of a DC-biased footprint is also shown below. In specific designs, the transmission line widths need to be adjusted to the unique dielectric coefficients and thicknesses as well as varying pick and place equipment tolerances.



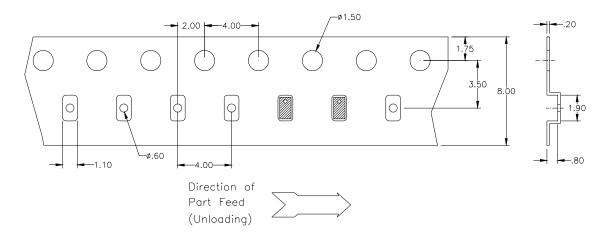


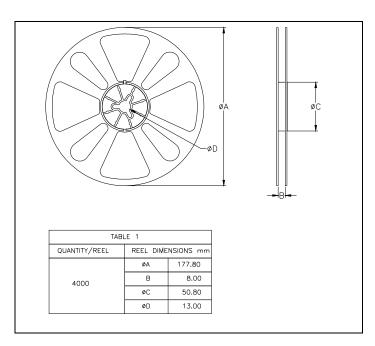


ModelBD3150L50100AHF

Packaging and Ordering Information

Parts are available in reel and are packaged per EIA 481-2. Parts are oriented in tape and reel as shown below. Minimum order quantities are 4000 per reel. See Model Numbers below for further ordering information.







Visit us at www.anaren.com

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Anaren:

BD3150L50100AHF